



# PMEG3010AESB

30 V, 1 A low VF MEGA Schottky barrier rectifier

8 January 2016

Product data sheet

## 1. General description

Planar Maximum Efficiency General Application (MEGA) Schottky barrier rectifier with an integrated guard ring for stress protection in a leadless ultra small DSN1006-2 (SOD993) Surface-Mounted Device (SMD) package.

## 2. Features and benefits

- Average forward current:  $I_{F(AV)} \leq 1$  A
- Reverse voltage:  $V_R \leq 30$  V
- Low forward voltage, typical:  $V_F = 415$  mV
- Low reverse current, typical:  $I_R = 300$   $\mu$ A
- Package height typ. 270  $\mu$ m

## 3. Applications

- Low voltage rectification
- High efficiency DC-to-DC conversion
- Switch mode power supply
- Low power consumption applications
- Ultra high-speed switching
- LED backlight for mobile application

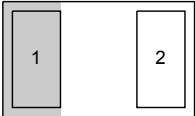

## 4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$I_{F(AV)}$	average forward current	$\delta = 0.5$ ; $f = 20$ kHz; $T_{sp} \leq 145$ °C; square wave	-	-	1	A
$V_R$	reverse voltage	$T_j = 25$ °C	-	-	30	V
$V_F$	forward voltage	$I_F = 1$ A; $t_p \leq 300$ $\mu$ s; $\delta \leq 0.02$ ; $T_j = 25$ °C	-	415	480	mV
$I_R$	reverse current	$V_R = 20$ V; $t_p \leq 3$ ms; $\delta \leq 0.3$ ; $T_j = 25$ °C	-	60	255	$\mu$ A
		$V_R = 30$ V; $t_p \leq 3$ ms; $\delta \leq 0.3$ ; $T_j = 25$ °C	-	300	1250	$\mu$ A

5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	K	cathode[1]	 Transparent top view <b>DSN1006-2 (SOD993)</b>	 <i>sym001</i>
2	A	anode		

[1] The marking bar indicates the cathode.

6. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
PMEG3010AESB	DSN1006-2	DSN1006-2, leadless ultra small package; 2 terminals; body 1.0 x 0.6 x 0.27 mm	SOD993

7. Marking

Table 4. Marking codes

Type number	Marking code
PMEG3010AESB	3A

## 8. Limiting values

**Table 5. Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
$V_R$	reverse voltage	$T_j = 25\text{ }^{\circ}\text{C}$		-	30	V
$I_F$	forward current	$T_{sp} \leq 140\text{ }^{\circ}\text{C}$ ; $\delta = 1$		-	1.4	A
$I_{F(AV)}$	average forward current	$\delta = 0.5$ ; $f = 20\text{ kHz}$ ; $T_{amb} \leq 115\text{ }^{\circ}\text{C}$ ; square wave	[1]	-	1	A
		$\delta = 0.5$ ; $f = 20\text{ kHz}$ ; $T_{sp} \leq 145\text{ }^{\circ}\text{C}$ ; square wave		-	1	A
$I_{FRM}$	repetitive peak forward current	$t_p \leq 1\text{ ms}$ ; $\delta \leq 0.25$		-	4	A
$I_{FSM}$	non-repetitive peak forward current	$t_p = 8\text{ ms}$ ; $T_{j(init)} = 25\text{ }^{\circ}\text{C}$ ; square wave		-	10	A
$P_{tot}$	total power dissipation	$T_{amb} \leq 25\text{ }^{\circ}\text{C}$	[2]	-	0.525	W
			[3]	-	1	W
			[1]	-	1.78	W
$T_j$	junction temperature			-	150	$^{\circ}\text{C}$
$T_{amb}$	ambient temperature			-55	150	$^{\circ}\text{C}$
$T_{stg}$	storage temperature			-65	150	$^{\circ}\text{C}$

[1] Device mounted on a ceramic Printed-Circuit Board (PCB),  $\text{Al}_2\text{O}_3$ , standard footprint.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

[3] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for anode and cathode  $1\text{ cm}^2$  each.

## 9. Thermal characteristics

**Table 6. Thermal characteristics**

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
$R_{th(j-a)}$	thermal resistance from junction to ambient	in free air	[1][2]	-	-	240	K/W
			[1][3]	-	-	125	K/W
			[1][4]	-	-	70	K/W
$R_{th(j-sp)}$	thermal resistance from junction to solder point		[5]	-	-	15	K/W

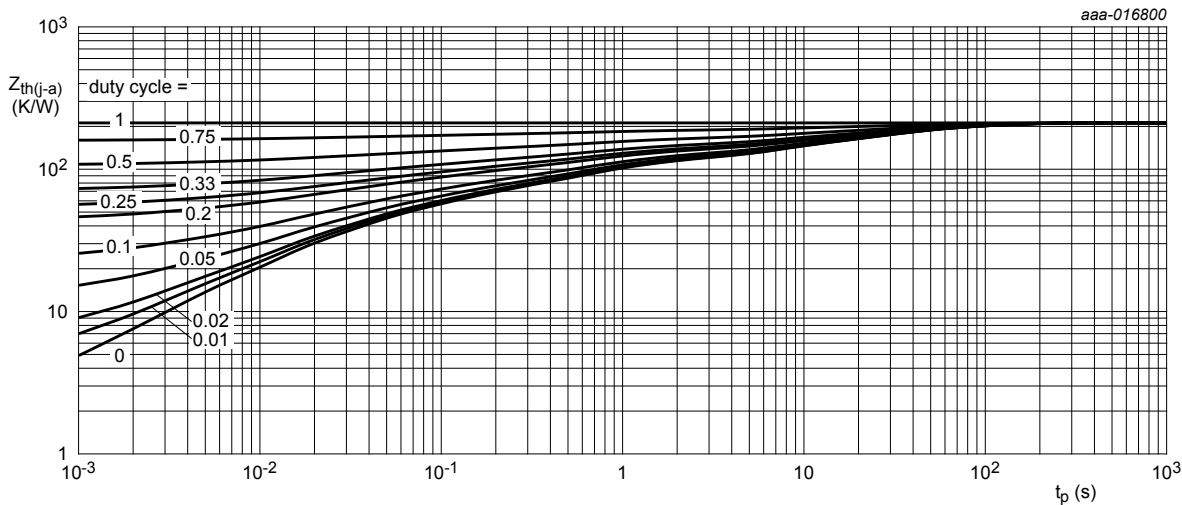
[1] For Schottky barrier diodes thermal runaway has to be considered, as in some applications the reverse power losses  $P_R$  are a significant part of the total power losses.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

[3] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for anode and cathode  $1\text{ cm}^2$  each.

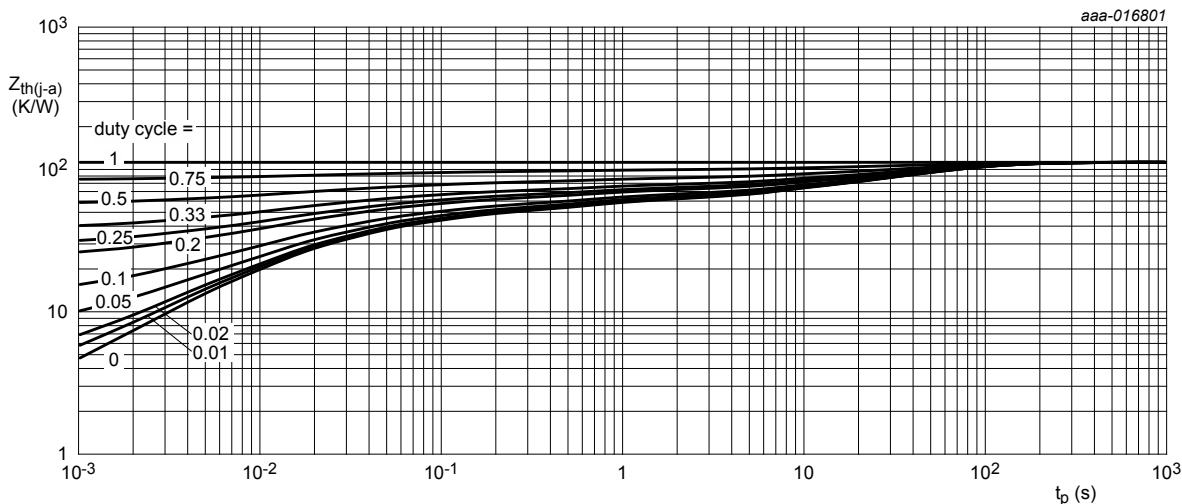
[4] Device mounted on a ceramic PCB,  $\text{Al}_2\text{O}_3$ , standard footprint.

[5] Soldering point of anode tab.



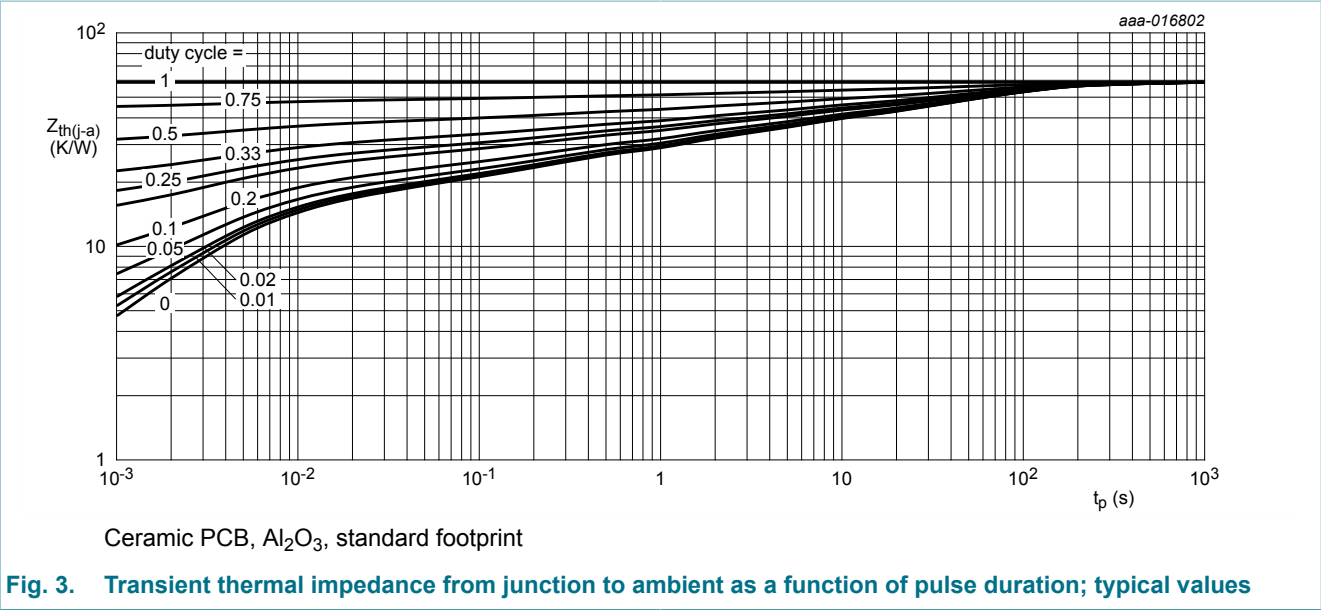
FR4 PCB, standard footprint

Fig. 1. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values



FR4 PCB, mounting pad for anode and cathode 1 cm<sup>2</sup> each

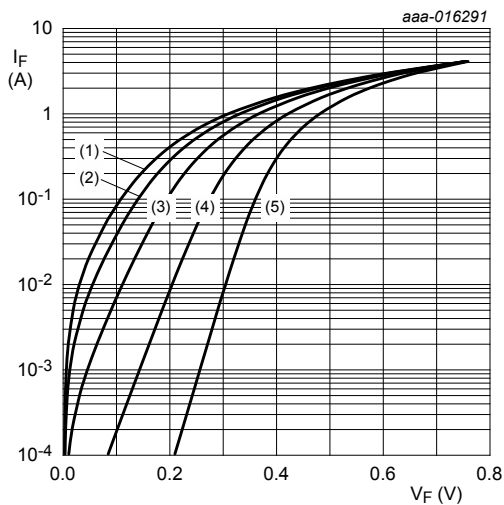
Fig. 2. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values



## 10. Characteristics

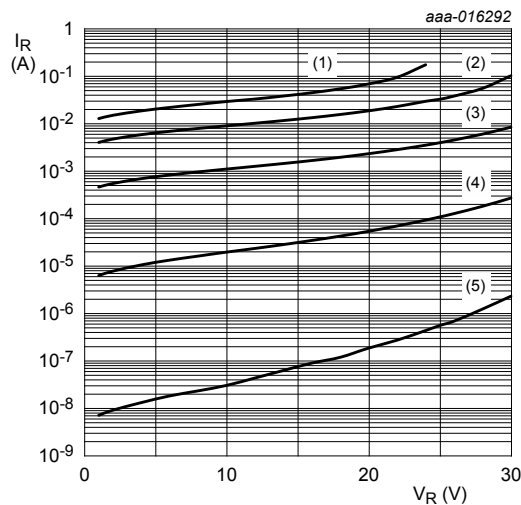
Table 7. Characteristics

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$V_{(BR)R}$	reverse breakdown voltage	$I_R = 10 \text{ mA}$ ; $t_p = 300 \text{ } \mu\text{s}$ ; $\delta = 0.02$ ; $T_J = 25 \text{ } ^\circ\text{C}$	30	-	-	V
$V_F$	forward voltage	$I_F = 1 \text{ mA}$ ; $t_p \leq 300 \text{ } \mu\text{s}$ ; $\delta \leq 0.02$ ; $T_J = 25 \text{ } ^\circ\text{C}$	-	140	-	mV
		$I_F = 10 \text{ mA}$ ; $t_p \leq 300 \text{ } \mu\text{s}$ ; $\delta \leq 0.02$ ; $T_J = 25 \text{ } ^\circ\text{C}$	-	200	-	mV
		$I_F = 100 \text{ mA}$ ; $t_p \leq 300 \text{ } \mu\text{s}$ ; $\delta \leq 0.02$ ; $T_J = 25 \text{ } ^\circ\text{C}$	-	270	325	mV
		$I_F = 200 \text{ mA}$ ; $t_p \leq 300 \text{ } \mu\text{s}$ ; $\delta \leq 0.02$ ; $T_J = 25 \text{ } ^\circ\text{C}$	-	300	-	mV
		$I_F = 500 \text{ mA}$ ; $t_p \leq 300 \text{ } \mu\text{s}$ ; $\delta \leq 0.02$ ; $T_J = 25 \text{ } ^\circ\text{C}$	-	355	405	mV
		$I_F = 700 \text{ mA}$ ; $t_p \leq 300 \text{ } \mu\text{s}$ ; $\delta \leq 0.02$ ; $T_J = 25 \text{ } ^\circ\text{C}$	-	380	-	mV
		$I_F = 1 \text{ A}$ ; $t_p \leq 300 \text{ } \mu\text{s}$ ; $\delta \leq 0.02$ ; $T_J = 25 \text{ } ^\circ\text{C}$	-	415	480	mV
$I_R$	reverse current	$V_R = 5 \text{ V}$ ; $t_p \leq 3 \text{ ms}$ ; $\delta \leq 0.3$ ; $T_J = 25 \text{ } ^\circ\text{C}$	-	13	-	$\mu\text{A}$
		$V_R = 10 \text{ V}$ ; $t_p \leq 3 \text{ ms}$ ; $\delta \leq 0.3$ ; $T_J = 25 \text{ } ^\circ\text{C}$	-	22	90	$\mu\text{A}$
		$V_R = 20 \text{ V}$ ; $t_p \leq 3 \text{ ms}$ ; $\delta \leq 0.3$ ; $T_J = 25 \text{ } ^\circ\text{C}$	-	60	255	$\mu\text{A}$
		$V_R = 30 \text{ V}$ ; $t_p \leq 3 \text{ ms}$ ; $\delta \leq 0.3$ ; $T_J = 25 \text{ } ^\circ\text{C}$	-	300	1250	$\mu\text{A}$
$C_d$	diode capacitance	$V_R = 1 \text{ V}$ ; $f = 1 \text{ MHz}$ ; $T_J = 25 \text{ } ^\circ\text{C}$	-	86	-	pF
		$V_R = 10 \text{ V}$ ; $f = 1 \text{ MHz}$ ; $T_J = 25 \text{ } ^\circ\text{C}$	-	32	-	pF
$t_{rr}$	reverse recovery time	$I_F = 0.5 \text{ A}$ ; $I_R = 0.5 \text{ A}$ ; $I_{R(\text{meas})} = 0.1 \text{ A}$ ; $T_J = 25 \text{ } ^\circ\text{C}$	-	3.5	-	ns



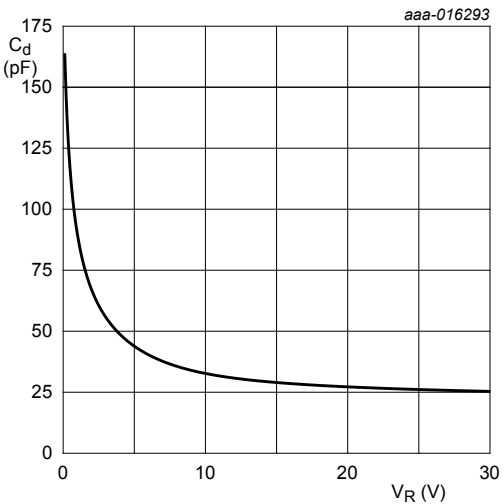
pulsed condition  
(1)  $T_j = 150\text{ }^{\circ}\text{C}$   
(2)  $T_j = 125\text{ }^{\circ}\text{C}$   
(3)  $T_j = 85\text{ }^{\circ}\text{C}$   
(4)  $T_j = 25\text{ }^{\circ}\text{C}$   
(5)  $T_j = -40\text{ }^{\circ}\text{C}$

Fig. 4. Forward current as a function of forward voltage; typical values



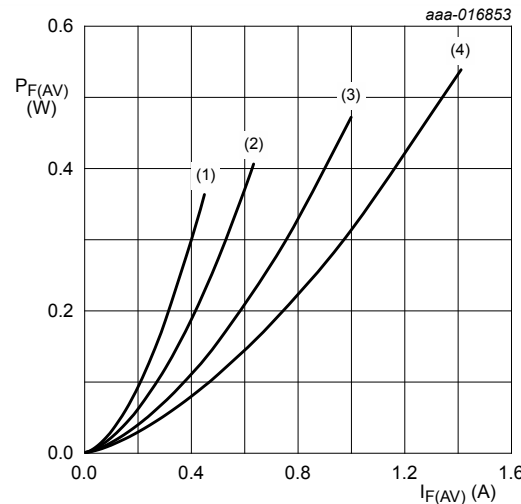
pulsed condition  
(1)  $T_j = 150\text{ }^{\circ}\text{C}$   
(2)  $T_j = 125\text{ }^{\circ}\text{C}$   
(3)  $T_j = 85\text{ }^{\circ}\text{C}$   
(4)  $T_j = 25\text{ }^{\circ}\text{C}$   
(5)  $T_j = -40\text{ }^{\circ}\text{C}$

Fig. 5. Reverse current as a function of reverse voltage; typical values



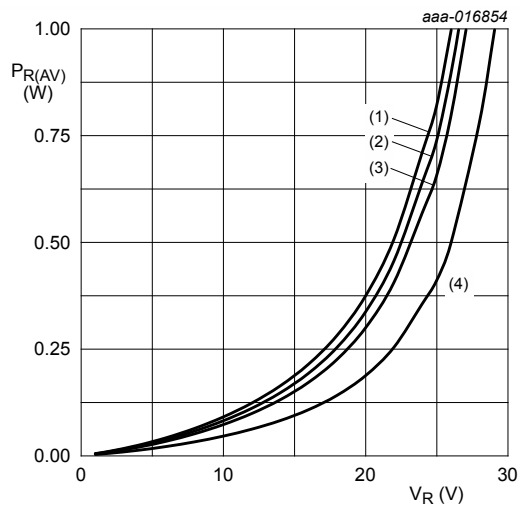
$f = 1\text{ MHz}$ ;  $T_{\text{amb}} = 25\text{ }^{\circ}\text{C}$

Fig. 6. Diode capacitance as a function of reverse voltage; typical values

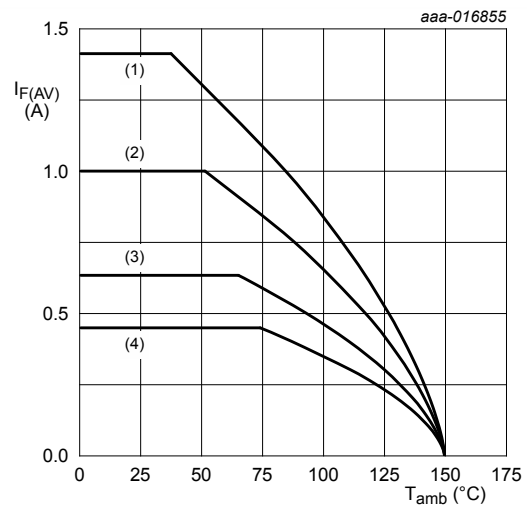


$T_j = 150\text{ }^{\circ}\text{C}$   
(1)  $\delta = 0.1$   
(2)  $\delta = 0.2$   
(3)  $\delta = 0.5$   
(4)  $\delta = 1$

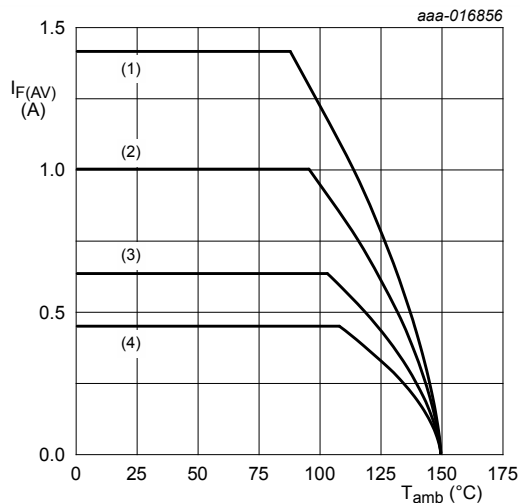
Fig. 7. Average forward power dissipation as a function of average forward current; typical values



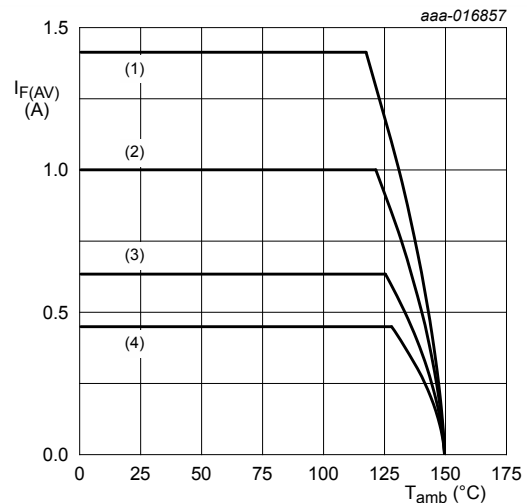
**Fig. 8.** Average reverse power dissipation as a function of reverse voltage; typical values



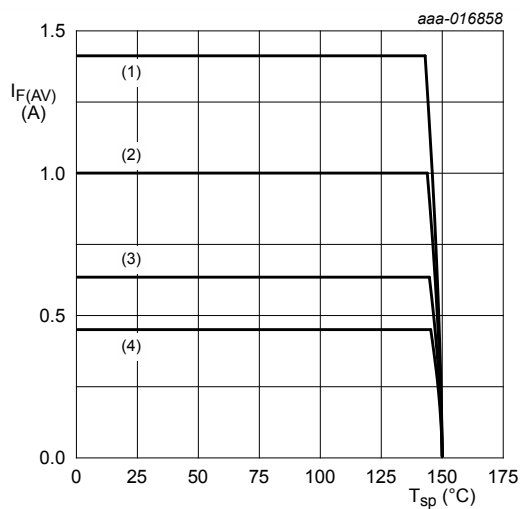
**Fig. 9.** Average forward current as a function of ambient temperature; typical values



**Fig. 10.** Average forward current as a function of ambient temperature; typical values



**Fig. 11.** Average forward current as a function of ambient temperature; typical values



$T_J = 150\text{ }^{\circ}\text{C}$

(1)  $\delta = 1$  (DC)

(2)  $\delta = 0.5$ ;  $f = 20\text{ kHz}$

(3)  $\delta = 0.2$ ;  $f = 20\text{ kHz}$

(4)  $\delta = 0.1$ ;  $f = 20\text{ kHz}$

**Fig. 12. Average forward current as a function of solder point temperature; typical values**

11. Test information

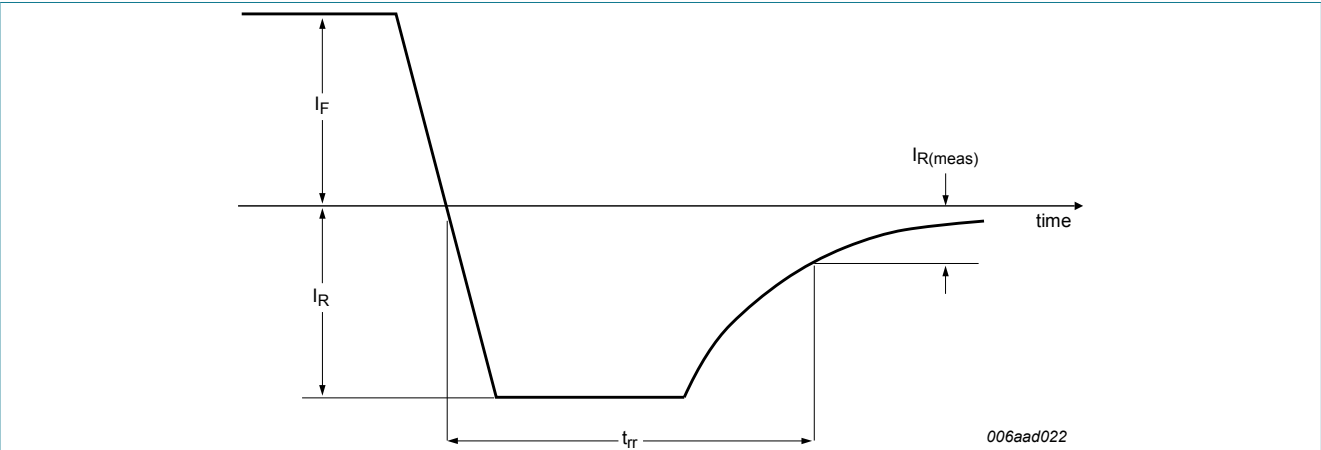


Fig. 13. Reverse recovery definition; step recovery

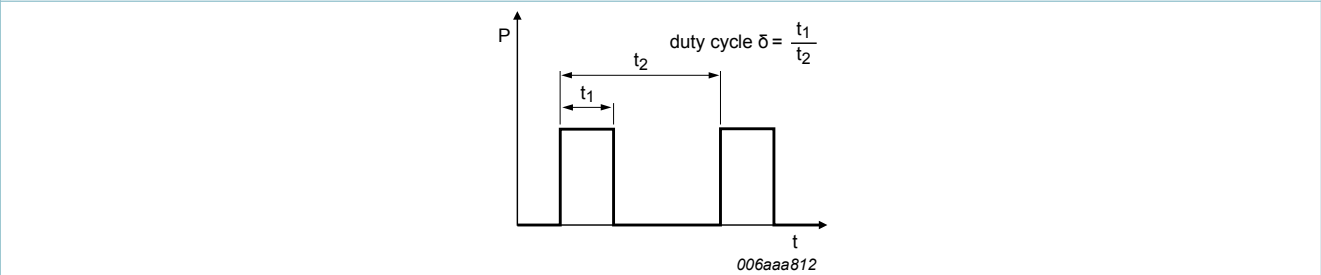


Fig. 14. Duty cycle definition

The current ratings for the typical waveforms are calculated according to the equations:  $I_{F(AV)} = I_M \times \delta$  with  $I_M$  defined as peak current,  $I_{RMS} = I_{F(AV)}$  at DC, and  $I_{RMS} = I_M \times \sqrt{\delta}$  with  $I_{RMS}$  defined as RMS current.

12. Package outline

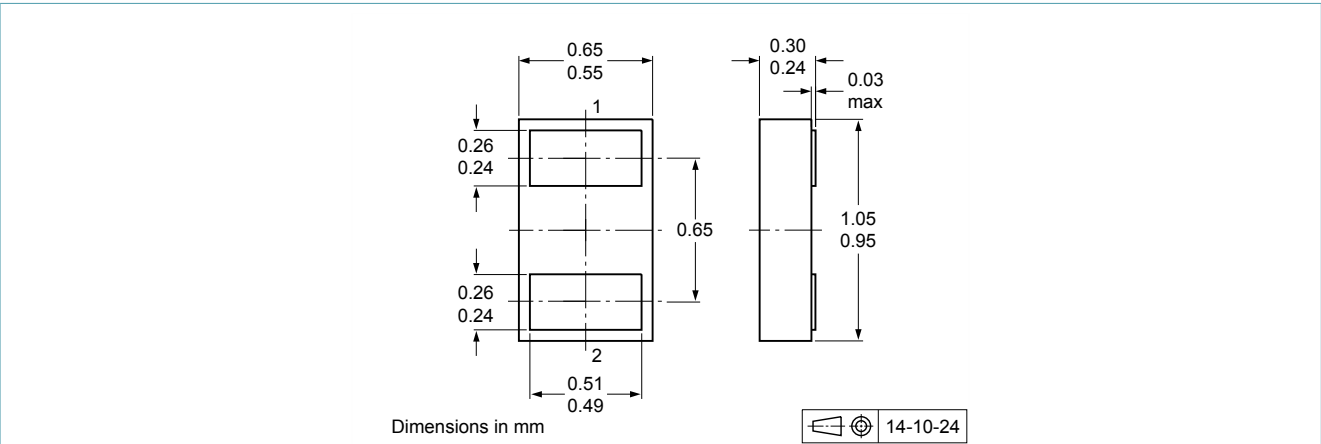


Fig. 15. Package outline DSN1006-2 (SOD993)

## 13. Soldering

SOD993

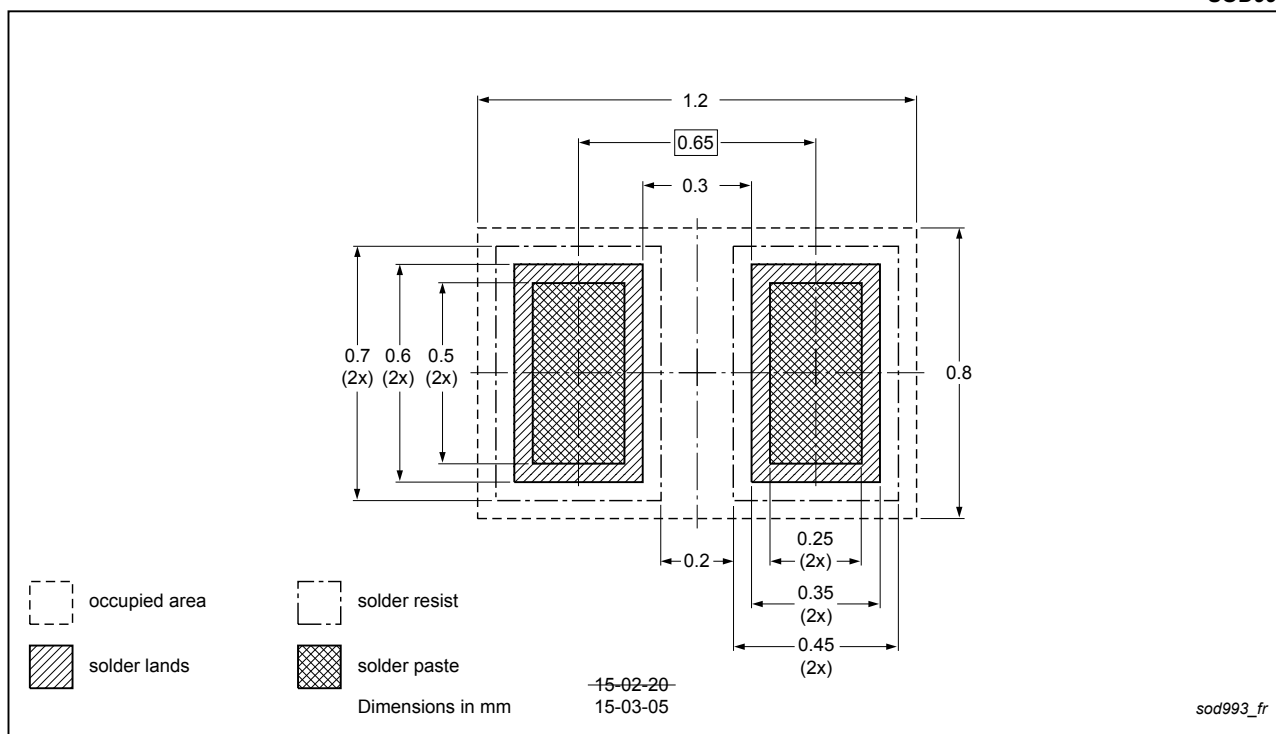


Fig. 16. Reflow soldering footprint for DSN1006-2 (SOD993)

## 14. Mounting

SOD993 is an ultra small Discretes Silicon No-leads (DSN) package allowing maximized utilization of the package area for active silicon. Due to the special product design, Nexperia investigated the board assembly process parameters. In order to have an optimum soldering quality, Nexperia advises following the assembly recommendations explained in [AN11689](#).

## 15. Revision history

Table 8. Revision history

Data sheet ID	Release date	Data sheet status	Change notice	Supersedes
PMEG3010AESB v.3	20160108	Product data sheet	-	PMEG3010AESB v.2
Modifications:	<ul style="list-style-type: none"><li>Section added: 14. Mounting</li></ul>			
PMEG3010AESB v.2	20150618	Product data sheet	-	PMEG3010AESB v.1
PMEG3010AESB v.1	20150506	Preliminary data sheet	-	-

## 16. Legal information

### 16.1 Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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- [2] The term 'short data sheet' is explained in section "Definitions".
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17. Contents

1 General description ..... 1

2 Features and benefits ..... 1

3 Applications ..... 1

4 Quick reference data ..... 1

5 Pinning information ..... 2

6 Ordering information ..... 2

7 Marking ..... 2

8 Limiting values ..... 3

9 Thermal characteristics ..... 3

10 Characteristics ..... 6

11 Test information ..... 10

12 Package outline ..... 10

13 Soldering ..... 11

14 Mounting ..... 11

15 Revision history ..... 12

16 Legal information ..... 13

16.1 Data sheet status ..... 13

16.2 Definitions ..... 13

16.3 Disclaimers ..... 13

16.4 Trademarks ..... 14

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Date of release: 08 January 2016